

LM137QML 3-Terminal Adjustable Negative Regulators

1 Features

- SMD 5962-99517
- Available TID Qualified to 30 krad(Si)
- Output Voltage Adjustable from -37 V to -1.2 V
- 1.5A Output Current Specified, -55°C to $+150^{\circ}\text{C}$
- Line Regulation Typically $0.01\%/V$
- Load Regulation Typically 0.3%
- Excellent Thermal Regulation, $0.002\%/W$
- 77 dB Ripple Rejection
- Excellent Rejection of Thermal Transients
- 50 ppm/ $^{\circ}\text{C}$ Temperature Coefficient
- Temperature-independent Current Limit
- Internal Thermal Overload Protection
- Standard 3-lead Transistor Package
- Output is Short Circuit Protected

2 Applications

- Multipurpose Power Supply
- On-card Voltage Regulation
- Programmable Voltage Supply
- Precision Current Supply
- Harsh Environments

3 Description

The LM137 are adjustable 3-terminal negative voltage regulators capable of supplying in excess of 1.5 A over an output voltage range of -37 V to -1.2 V . These regulators are exceptionally easy to apply, requiring only 2 external resistors to set the output voltage and 1 output capacitor for frequency compensation. The circuit design has been optimized for excellent regulation and low thermal transients. Further, the LM137 series features internal current limiting, thermal shutdown and safe-area compensation, making them virtually blowout-proof against overloads.

The LM137 serve a wide variety of applications including local on-card regulation, programmable-output voltage regulation or precision current regulation. The LM137 are ideal complements to the LM117 adjustable positive regulators.

Device Information⁽¹⁾

PART NUMBER	SMD NUMBER	PACKAGE
LM137K/883		TO-3 (K)
LM137H/883		TO-39 (NDT)
LM137H1PQMLV	5962P9951708VXA 30 krad	TO-39 (NDT)
LM137H-MD8		Die
LM137KG-MD8		Die
LM137KG-MW8		Wafer

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Schematic

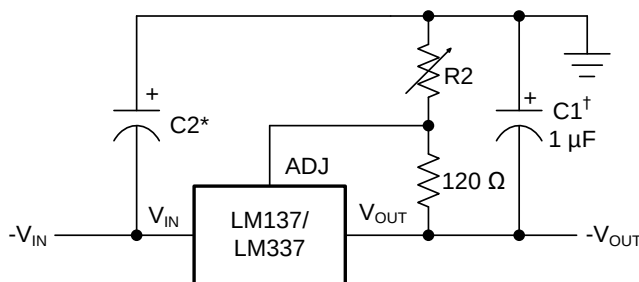


Table of Contents

1 Features	1	Parameters 5962P9951708VXA	9
2 Applications	1	6.12 LM137H RH Electrical Characteristics DC	
3 Description	1	Parameters Drift Values 5962P9951708VXA	9
4 Revision History	2	6.13 LM137H RH Electrical Characteristics DC	
5 Pin Configuration and Functions	3	Parameters Post Radiation Limits +25°C	
6 Specifications	4	5962P9951708VXA	9
6.1 Absolute Maximum Ratings	4	6.14 Typical Performance Characteristics	10
6.2 ESD Ratings	4	7 Detailed Description	12
6.3 Recommended Operating Conditions	4	7.1 Functional Block Diagram	12
6.4 Thermal Information	4	8 Application and Implementation	13
6.5 Quality Conformance Inspection	5	8.1 Application Information and Schematic Diagram	13
6.6 LM137H 883 Electrical Characteristics DC		8.2 Typical Applications	13
Parameters	6	9 Power Supply Recommendations	16
6.7 LM137H 883 Electrical Characteristics AC		9.1 Thermal Regulation	16
Parameters	6	10 Device and Documentation Support	17
6.8 LM137K 883 Electrical Characteristics DC		10.1 Receiving Notification of Documentation Updates	17
Parameters	7	10.2 Community Resources	17
6.9 LM137K 883 Electrical Characteristics AC		10.3 Trademarks	17
Parameters	7	10.4 Electrostatic Discharge Caution	17
6.10 LM137H RH Electrical Characteristics DC		10.5 Glossary	17
Parameters 5962P9951708VXA	8	11 Mechanical, Packaging, and Orderable	
6.11 LM137H RH Electrical Characteristics AC		Information	17

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision E (December 2016) to Revision F	Page
• Changed the T0-39 Metal Can Package From: Top View To: Bottom View	3

Changes from Revision D (February 2015) to Revision E	Page
• Updated the package orderable addendum	1

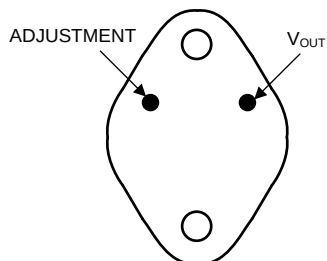
Changes from Revision C (April 2013) to Revision D	Page
• Added, updated, or renamed the following sections: Device Information table, <i>Specifications</i> , <i>Feature Description</i> , <i>Layout</i> , <i>Application and Implementation</i> , <i>Power supply Recommendations</i> , <i>Device and Documentation Support</i> , <i>Mechanical, Packaging, and Ordering Information</i>	1
• Changed Vout Recovery condition from -4.25 V to -40 V	9

Changes from Revision B (March 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format.	1

Changes from Revision A (December 2010) to Revision B	Page
• Added new LM137H1PQMLV to <i>Ordering Information</i>	1
• Added to the HEADER of DC Parameters — Post Radiation Limits 5962P9951701VXA. Added the HEADER and TABLE of DC Parameters — Post Radiation Limits 5962P9951708VXA for <i>Electrical Characteristics</i> tables	6

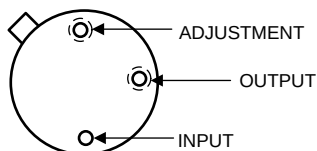
5 Pin Configuration and Functions

**TO-3 Metal Can Package
Package K
(Bottom View)**



NOTE: Case is Input

**T0-39 Metal Can Package
Package NDT
(Bottom View)**



NOTE: Case Is Input

Pin Functions

PIN			I/O	DESCRIPTION
NAME	NUMBER			
	K	NDT		
ADJUSTMENT	1	1	O	Adjustment
INPUT	Case	3/Case	I	Input
OUTPUT I_{OUT}	2	2	O	Output

6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾

			UNIT
Power Dissipation ⁽²⁾		Internally Limited	
Input-Output Voltage Differential		40	V
Operating Ambient Temperature		$-55 \leq T_A \leq +125$	°C
Operating Junction Temperature		$-55 \leq T_J \leq +150$	°C
Storage Temperature		$-65 \leq T_A \leq +150$	°C
Maximum Junction Temperature		150	°C
Lead Temperature (Soldering, 10 sec.)		300	°C
Maximum Power Dissipation (@25°C)	T0–3	28	W
	T0–39	2.5	W
Package Weight (typical)	T0–3	12,750	mg
	T0–39 Metal Can	955	mg

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), $R_{\theta JA}$ (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/R_{\theta JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±4000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions. Pins listed as ±4000 V may actually have higher performance. Human body model, 100 pF discharged through 1.5 KΩ.

6.3 Recommended Operating Conditions

	MIN	MAX	UNIT
T_A		$-55 \leq T_A \leq +125$	°C
Input Voltage	–41.25	–4.25	V

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TO-3 METAL CAN	TO-39 METAL CAN	UNIT
		2 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	40 (Still Air)	174 (Still Air @ 0.5W)	°C/W
		14 (500 LFM)	64 (500 LFM @ 0.5W)	
$R_{\theta JC}$	Junction-to-case thermal resistance	4	15 (@ 1.0W)	

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Quality Conformance Inspection

Table 1. Mil-Std-883, Method 5005 — Group A⁽¹⁾

SUBGROUP	DESCRIPTION	TEMP (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

(1) Group "A" sample only, test at all temps.

6.6 LM137H 883 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. $V_{IN} = -4.25V$, $I_L = 8mA$, $V_{OUT} = V_{Ref}^{(1)(2)}$

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
V_{Ref} Reference Voltage		1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
	$V_{IN} = -42V$	1	-1.275	-1.225	V
	$V_{IN} = -41.3V$	2, 3	-1.3	-1.2	V
I_Q Minimum Load Current	$V_{OUT} = -1.7V$	1, 2, 3		3.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -11.75V$	1, 2, 3		3.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -42V$	1		5.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -41.3V$	2, 3		5.0	mA
R_{Line} Line Regulation	$-42V \leq V_{IN} \leq -4.25V$	1	-9.0	9.0	mV
	$-41.3V \leq V_{IN} \leq -4.25V$	2, 3	-23	23	mV
R_{Load} Load Regulation	$5mA \leq I_L \leq 500mA$, $V_{IN} = -6.25V$	1, 2, 3	-25	25	mV
	$5mA \leq I_L \leq 500mA$, $V_{IN} = -14.5V$	1	-25	25	mV
	$5mA \leq I_L \leq 150mA$, $V_{IN} = -40V$	1, 2, 3	-25	25	mV
I_{Adj} Adjustment Pin Current	$I_L = 5mA$	1, 2, 3		100	μA
	$V_{IN} = -42V$	1		100	μA
	$V_{IN} = -41.3V$	2, 3		100	μA
$\Delta I_{Adj} / V_{Line}$ Adjust Pin Current Change vs. Line Voltage	$-42V \leq V_{IN} \leq -4.25V$, $I_L = 5mA$	1	-5.0	5.0	μA
	$-41.3V \leq V_{IN} \leq -4.25V$, $I_L = 5mA$	2, 3	-5.0	5.0	μA
$\Delta I_{Adj} / I_{Load}$ Adjust Pin Current Change vs. Load Current	$5mA \leq I_L \leq 500mA$, $V_{IN} = -6.5V$	1, 2, 3	-5.0	5.0	μA
V_{Rth} Thermal Regulation	$V_{IN} = -14.5V$, $I_L = 500mA$, $t = 10mS$	1	-5.0	5.0	mV
	$V_{IN} = -14.5V$, $I_L = 5mA$, $t = 10mS$	1	-5.0	5.0	mV
I_{CL} Current Limit	$V_{IN} = -5V$	1, 2, 3	-1.8	-0.5	A
	$V_{IN} = -40V$	1, 2, 3	-0.65	-0.15	A
V_O Output Voltage		1	-1.28	-1.22	V
		2, 3	-1.3	-1.2	V

(1) $V_{IN} = -41.3V$ at $+125^\circ C$ and $-55^\circ C$

(2) $-41.3V \leq V_{IN} \leq -4.25V$ at $+125^\circ C$ and $-55^\circ C$

6.7 LM137H 883 Electrical Characteristics AC Parameters

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
R_R Ripple Rejection Ratio ⁽¹⁾	$V_{IN} = -6.25V$, $V_{OUT} = V_{Ref}$, $I_L = 125mA$, $e_i = 1V_{RMS}$, $F = 120Hz$	4,5,6	66		dB

(1) Test at $+25^\circ C$, ensured but not tested at $+125^\circ C$ and $-55^\circ C$

6.8 LM137K 883 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. $V_{IN} = -4.25V$, $I_L = 8mA$, $V_{OUT} = V_{Ref}^{(1)(2)}$

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
V_{Ref} Reference Voltage		1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
	$V_{IN} = -42V$	1	-1.275	-1.225	V
	$V_{IN} = -41.3V$	2, 3	-1.3	-1.2	V
I_Q Minimum Load Current	$V_{OUT} = -1.7V$	1, 2, 3		3.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -11.75V$	1, 2, 3		3.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -42V$	1		5.0	mA
	$V_{OUT} = -1.7V$, $V_{IN} = -41.3V$	2, 3		5.0	mA
R_{Line} Line Regulation	$-42V \leq V_{IN} \leq -4.25V$	1	-9.0	9.0	mV
	$-41.3V \leq V_{IN} \leq -4.25V$	2, 3	-23	23	mV
R_{Load} Load Regulation	$V_{IN} = -6.25V$, $8mA \leq I_L \leq 1.5A$	1, 2, 3	-25	25	mV
	$V_{IN} = -14.5V$, $8mA \leq I_L \leq 1.5A$	1	-25	25	mV
	$V_{IN} = -40V$, $8mA \leq I_L \leq 300mA$	1	-25	25	mV
	$V_{IN} = -40V$, $8mA \leq I_L \leq 250mA$	2, 3	-25	25	mV
I_{Adj} Adjustment Pin Current		1, 2, 3		100	μA
	$V_{IN} = -42V$	1		100	μA
	$V_{IN} = -41.3V$	2, 3		100	μA
$\Delta I_{Adj} / V_{Line}$ Adjust Pin Current Change vs. Line Voltage	$-42V \leq V_{IN} \leq -4.25V$	1	-5.0	5.0	μA
	$-41.3V \leq V_{IN} \leq -4.25V$	2, 3	-5.0	5.0	μA
$\Delta I_{Adj} / I_{Load}$ Adjust Pin Current Change vs. Load Current	$8mA \leq I_L \leq 1.5A$, $V_{IN} = -6.25V$	1, 2, 3	-5.0	5.0	μA
V_{Rth} Thermal Regulation	$V_{IN} = -14.5V$, $I_L = 1.5mA$, $t = 10mS$	1	-5.0	5.0	mV
	$V_{IN} = -14.5V$, $I_L = 8mA$, $t = 10mS$	1	-5.0	5.0	mV
I_{CL} Current Limit	$V_{IN} = -5V$	1, 2, 3	-3.5	-1.5	A
	$V_{IN} = -40V$	1, 2, 3	-1.2	-0.24	A

(1) $V_{IN} = -41.3V$ at $+125^\circ C$ and $-55^\circ C$

(2) $-41.3V \leq V_{IN} \leq -4.25V$ at $+125^\circ C$ and $-55^\circ C$

6.9 LM137K 883 Electrical Characteristics AC Parameters

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
R_R Ripple Rejection Ratio ⁽¹⁾	$V_{IN} = -6.25V$, $V_{OUT} = V_{Ref}$, $f = 120Hz$, $I_L = 0.5A$, $e_i = 1V_{RMS}$	4,5,6	66		dB

(1) Test at $+25^\circ C$, ensured but not tested at $+125^\circ C$ and $-55^\circ C$

LM137QML

SNVS313F – DECEMBER 2010 – REVISED AUGUST 2018

www.ti.com

6.10 LM137H RH Electrical Characteristics DC Parameters 5962P9951708VXA

The following conditions apply, unless otherwise specified. ⁽¹⁾

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
V_{OUT} Output Voltage	$V_{IN} = -4.25\text{ V}$, $I_L = 5\text{ mA}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
	$V_{IN} = -4.25\text{ V}$, $I_L = 500\text{ mA}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
$V_{R\text{ Line}}$ Line Regulation	$V_{IN} = -41.25\text{ V to } -4.25\text{ V}$, $I_L = 5\text{ mA}$	1	-9.0	9.0	mV
		2, 3	-23	23	mV
$V_{R\text{ Load}}$ Load Regulation	$V_{IN} = -6.25\text{ V}$, $I_L = 5\text{ mA to } 500\text{ mA}$	1	-12	12	mV
		2, 3	-24	24	mV
	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA to } 50\text{ mA}$	1	-6.0	6.0	mV
		2, 3	-12	12	mV
	$V_{IN} = -6.25\text{ V}$, $I_L = 5\text{ mA to } 200\text{ mA}$	1	-6.0	6.0	mV
		2, 3	-12	12	mV
V_{Rth} Thermal Regulation	$V_{IN} = -14.6\text{ V}$, $I_L = 500\text{ mA}$	1	-5.0	5.0	mV
I_{Adj} Adjust Pin Current	$V_{IN} = -4.25\text{ V}$, $I_L = 5\text{ mA}$	1, 2, 3	25	100	μA
	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1, 2, 3	25	100	μA
$\Delta I_{Adj} / V_{Line}$ Adjust Pin Current Change vs. Line Voltage	$V_{IN} = -41.25\text{ V to } -4.25\text{ V}$, $I_L = 5\text{ mA}$	1, 2, 3	-5.0	5.0	μA
$\Delta I_{Adj} / I_{Load}$ Adjust Pin Current Change vs. Load Current	$V_{IN} = -6.25\text{ V}$, $I_L = 5\text{ mA to } 500\text{ mA}$	1, 2, 3	-5.0	5.0	μA
I_{OS} Output Short Circuit Current	$V_{IN} = -4.25\text{ V}$	1, 2, 3	0.5	1.8	A
	$V_{IN} = -40\text{ V}$	1, 2, 3	0.05	0.5	A
$V_{OUT\text{ Recovery}}$ Output Voltage Recovery After Output Short Circuit Current	$V_{IN} = -4.25\text{ V}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
	$V_{IN} = -40\text{ V}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
I_Q Minimum Load Current	$V_{IN} = -4.25\text{ V}$	1, 2, 3	0.2	3.0	mA
	$V_{IN} = -14.25\text{ V}$	1, 2, 3	0.2	3.0	mA
	$V_{IN} = -41.25\text{ V}$	1, 2, 3	1.0	5.0	mA
V_{Start} Voltage Start-up	$V_{IN} = -4.25\text{ V}$, $I_L = 500\text{ mA}$	1	-1.275	-1.225	V
		2, 3	-1.3	-1.2	V
V_{OUT} Output Voltage ⁽²⁾	$V_{IN} = -6.25\text{ V}$, $I_L = 5\text{ mA}$	2	-1.3	-1.2	V

(1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are specified only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

(2) Tested at +125°C; correlated to +150°C

6.11 LM137H RH Electrical Characteristics AC Parameters 5962P9951708VXA

The following conditions apply, unless otherwise specified.⁽¹⁾

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
$\Delta V_{IN} / \Delta V_{OUT}$ Ripple Rejection	$V_{IN} = -6.25\text{ V}$, $I_L = 125\text{ mA}$, $e_f = 1V_{RMS}$ at 2400 Hz	9	48		dB
V_{NO} Output Noise Voltage	$V_{IN} = -6.25\text{ V}$, $I_L = 50\text{ mA}$	9		120	μV_{RMS}
$\Delta V_{OUT} / \Delta V_{IN}$ Line Transient Response	$V_{IN} = -6.25\text{ V}$, $V_{Pulse} = -1V$, $I_L = 50\text{ mA}$	9		80	mV/V
$\Delta V_O / \Delta I_L$ Load Transient Response ⁽²⁾	$V_{IN} = -6.25\text{ V}$, $I_L = 50\text{ mA}$, $\Delta I_L = 200\text{ mA}$	9		60	mV

- (1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are specified only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.
- (2) Limit of 0.3mV/mA is equivalent to 60mV

6.12 LM137H RH Electrical Characteristics DC Parameters Drift Values 5962P9951708VXA

The following conditions apply, unless otherwise specified.⁽¹⁾

Delta calculations performed on QMLV devices at group B, subgroup 5 only.

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
V_{OUT} Output Voltage	$V_{IN} = -4.25\text{ V}$, $I_L = 5\text{ mA}$	1	-0.01	0.01	V
	$V_{IN} = -4.25\text{ V}$, $I_L = 500\text{ mA}$	1	-0.01	0.01	V
	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1	-0.01	0.01	V
	$V_{IN} = -41.25\text{ V}$, $I_L = 50\text{ mA}$	1	-0.01	0.01	V
$V_{R\text{ Line}}$ Line Regulation	$V_{IN} = -41.25\text{ V}$ to -4.25 V , $I_L = 5\text{ mA}$	1	-4.0	4.0	mV
I_{Adj} Adjust Pin Current	$V_{IN} = -4.25\text{ V}$, $I_L = 5\text{ mA}$	1	-10	10	μA
	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1	-10	10	μA

- (1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are specified only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

6.13 LM137H RH Electrical Characteristics DC Parameters Post Radiation Limits +25°C 5962P9951708VXA

The following conditions apply, unless otherwise specified.⁽¹⁾

PARAMETER	TEST CONDITIONS	SUB-GROUPS	MIN	MAX	UNIT
V_{OUT} Output Voltage	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1	-1.30	-1.225	V
	$V_{IN} = -41.25\text{ V}$, $I_L = 50\text{ mA}$	1	-1.30	-1.225	V
$V_{R\text{ Line}}$ Line Regulation	$V_{IN} = -41.25\text{ V}$ to -4.25 V , $I_L = 5\text{ mA}$	1	-9.0	+50	mV
I_{Adj} Adjust Pin Current	$V_{IN} = -41.25\text{ V}$, $I_L = 5\text{ mA}$	1	25	140	μA
$\Delta I_{Adj} / V_{Line}$ Adjust Pin Current Change vs. Line Voltage	$V_{IN} = -41.25\text{ V}$ to -4.25 V , $I_L = 5\text{ mA}$	1	-70	+20	μA
$V_{OUT\text{ Recovery}}$ Output Voltage Recovery After Output Short Circuit Current	$V_{IN} = -40\text{ V}$	1	-1.30	-1.225	V

- (1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are specified only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

6.14 Typical Performance Characteristics

(NDT & K Packages)

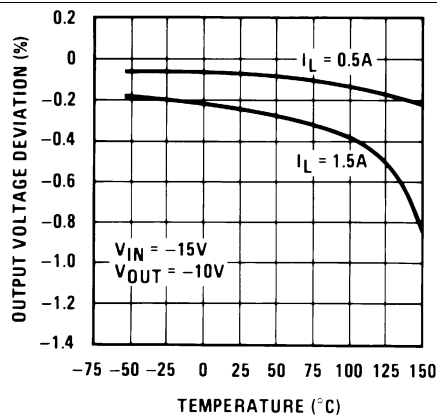


Figure 1. Load Regulation

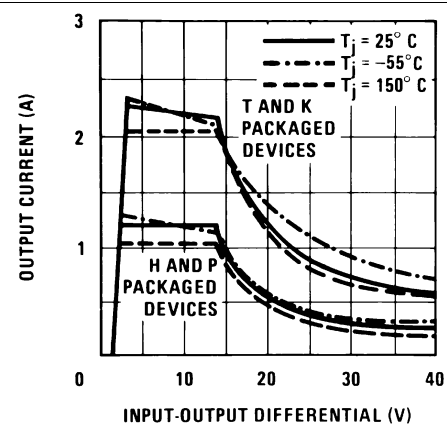


Figure 2. Current Limit

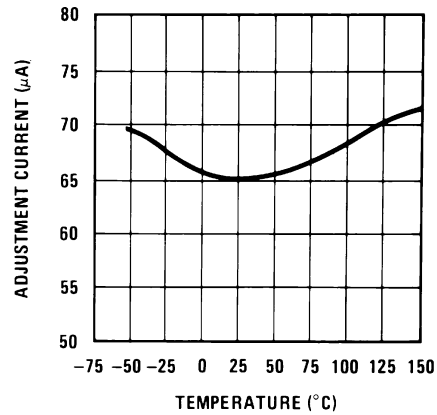


Figure 3. Adjustment Current

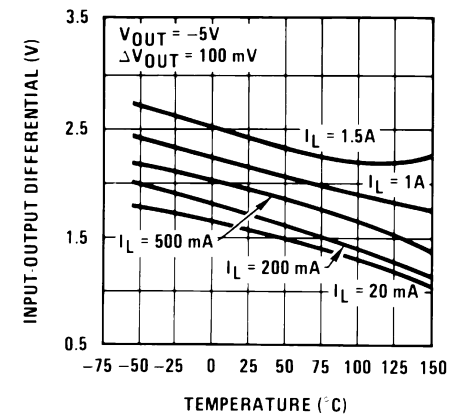


Figure 4. Dropout Voltage

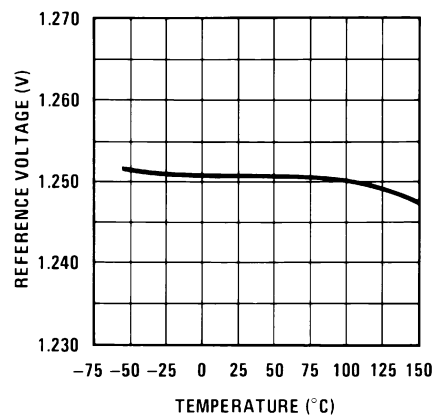


Figure 5. Temperature Stability

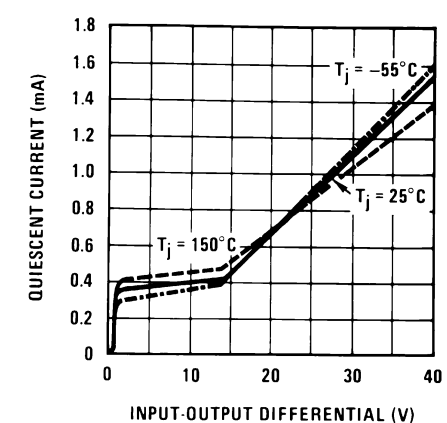


Figure 6. Minimum Operating Current

Typical Performance Characteristics (continued)

(NDT & K Packages)

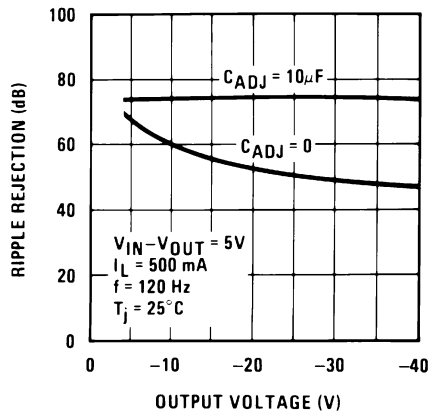


Figure 7. Ripple Rejection

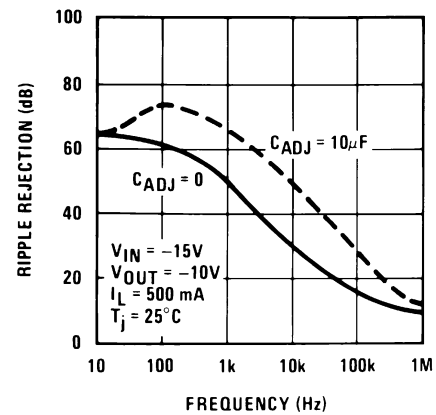


Figure 8. Ripple Rejection

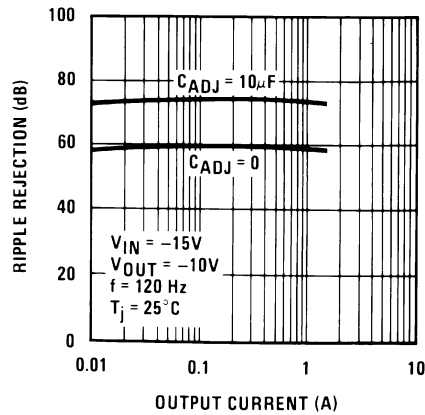


Figure 9. Ripple Rejection

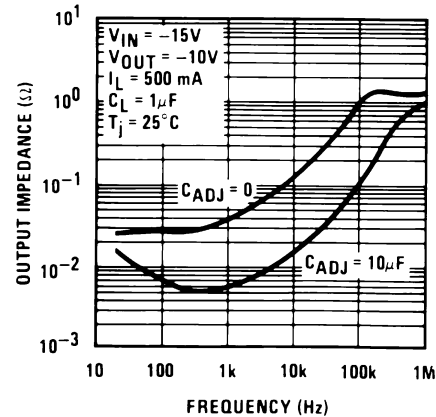


Figure 10. Output Impedance

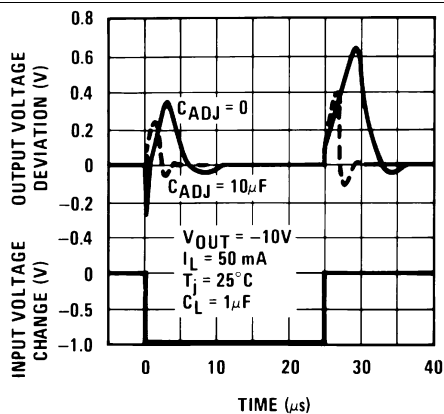


Figure 11. Line Transient Response

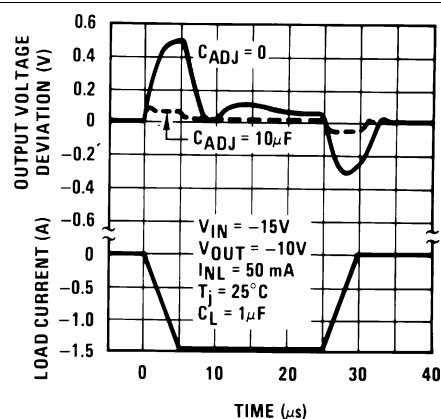


Figure 12. Load Transient Response

7 Detailed Description

7.1 Functional Block Diagram

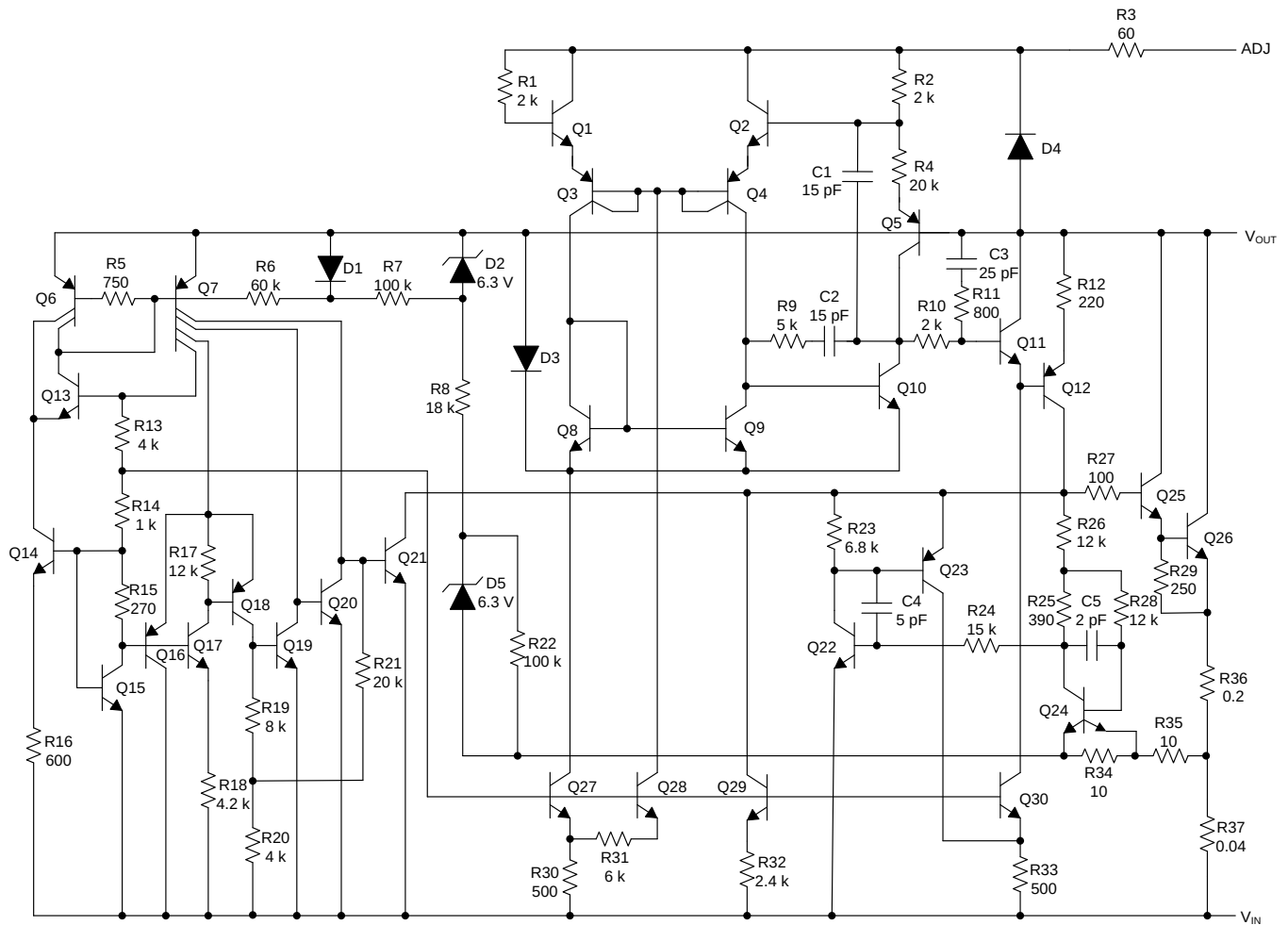


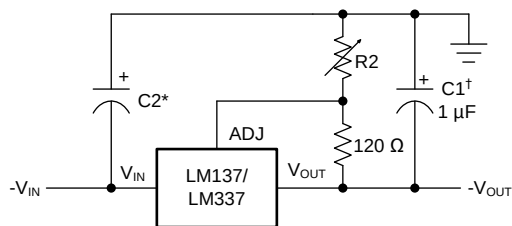
Figure 13. Schematic Diagram

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information and Schematic Diagram



Full output current not available at high input-output voltages

$$-V_{OUT} = 1.25 \left(V_1 + \frac{R_2}{120} \right) + (-I_{ADJ} \times R_2)$$

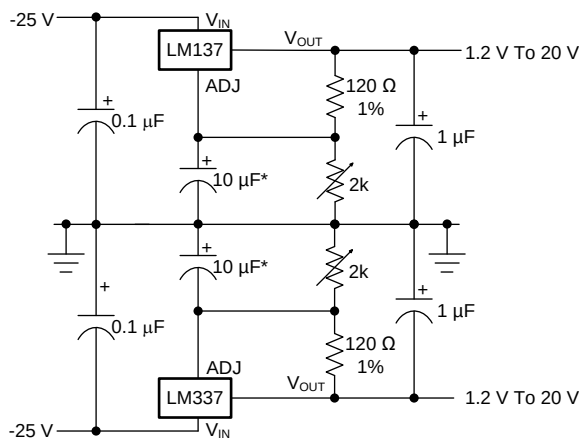
†C1 = 1 μF solid tantalum or 10 μF aluminum electrolytic required for stability

*C2 = 1 μF solid tantalum is required only if regulator is more than 4" from power-supply filter capacitor

Output capacitors in the range of 1 μF to 1000 μF of aluminum or tantalum electrolytic are commonly used to provide improved output impedance and rejection of transients

Figure 14. Adjustable Negative Voltage Regulator

8.2 Typical Applications



Full output current not available
at high input-output voltages

*The 10 μF capacitors are optional to improve ripple rejection

Figure 15. Adjustable Lab Voltage Regulator

Typical Applications (continued)

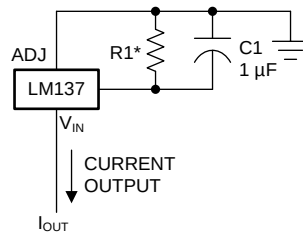
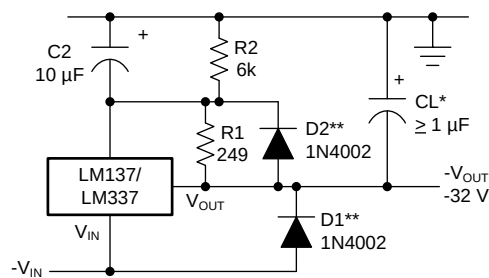


Figure 16. Current Regulator

$$I_{OUT} = \frac{1.250 \text{ V}}{R1}$$

$$*0.8 \Omega \leq R1 \leq 120 \Omega$$

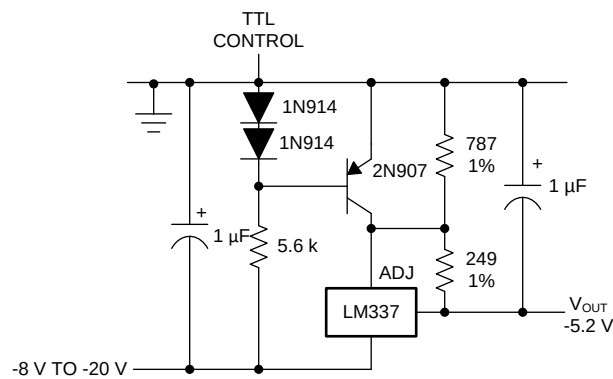
(1)



*When C_L is larger than $20 \mu\text{F}$, D1 protects the LM137 in case the input supply is shorted

**When C_L is larger than $10 \mu\text{F}$ and $-V_{OUT}$ is larger than -25V , D2 protects the LM137 in case the output is shorted

Figure 17. Negative Regulator with Protection Diodes



*Minimum output $\approx -1.3\text{V}$ when control input is low

Figure 18. -5.2V Regulator with Electronic Shutdown*

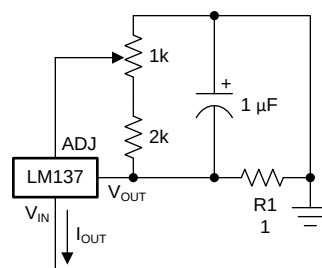


Figure 19. Adjustable Current Regulator

Typical Applications (continued)

$$I_{OUT} = \left(\frac{1.5 \text{ V}}{R1} \right) \pm 15\% \text{ adjustable}$$

(2)

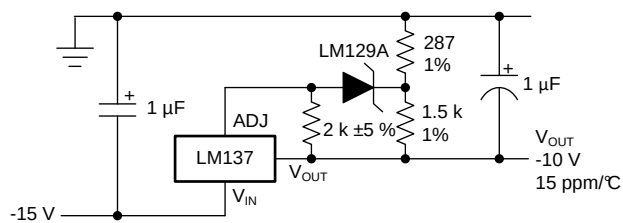
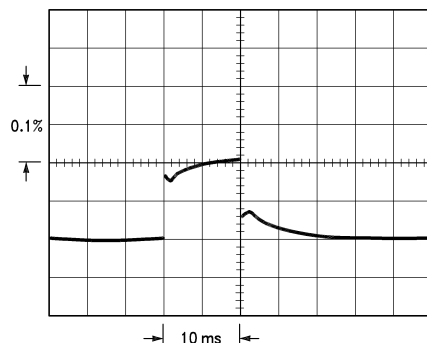


Figure 20. High Stability -10V Regulator

9 Power Supply Recommendations

9.1 Thermal Regulation

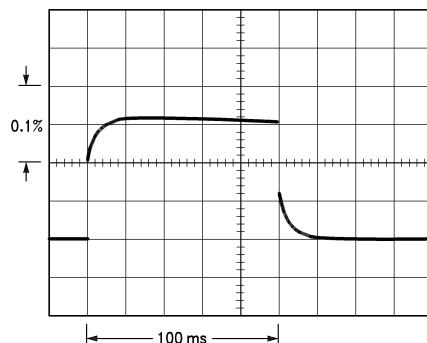
When power is dissipated in an IC, a temperature gradient occurs across the IC chip affecting the individual IC circuit components. With an IC regulator, this gradient can be especially severe since power dissipation is large. Thermal regulation is the effect of these temperature gradients on output voltage (in percentage output change) per Watt of power change in a specified time. Thermal regulation error is independent of electrical regulation or temperature coefficient, and occurs within 5 ms to 50 ms after a change in power dissipation. Thermal regulation depends on IC layout as well as electrical design. The thermal regulation of a voltage regulator is defined as the percentage change of V_{OUT} , per Watt, within the first 10 ms after a step of power is applied. The LM137's specification is 0.02%/W, max.



LM137, $V_{OUT} = -10V$ $V_{IN} - V_{OUT} = -40V$
 Horizontal sensitivity, 5 ms/div $I_L = 0A \rightarrow 0.25A \rightarrow 0A$

Figure 21.

In [Figure 21](#), a typical LM137's output drifts only 3 mV (or 0.03% of $V_{OUT} = -10V$) when a 10W pulse is applied for 10 ms. This performance is thus well inside the specification limit of $0.02\%/W \times 10W = 0.2\%$ max. When the 10W pulse is ended, the thermal regulation again shows a 3 mV step as the LM137 chip cools off. Note that the load regulation error of about 8 mV (0.08%) is additional to the thermal regulation error. In [Figure 22](#), when the 10W pulse is applied for 100 ms, the output drifts only slightly beyond the drift in the first 10 ms, and the thermal error stays well within 0.1% (10 mV).



LM137, $V_{OUT} = -10V$ $V_{IN} - V_{OUT} = -40V$
 Horizontal sensitivity, 20 ms/div $I_L = 0A \rightarrow 0.25A \rightarrow 0A$

Figure 22.

10 Device and Documentation Support

10.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

10.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

10.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

10.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

10.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962P9951708VXA	Active	Production	TO (NDT) 3	20 JEDEC TRAY (5+1)	-	Call TI	Call TI	-55 to 125	LM137H1PQMLV 5962P9951708VXA Q ACO 5962P9951708VXA Q >T
LM137H MD8	Active	Production	DIESALE (Y) 0	120 JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM137H/883	Active	Production	TO (NDT) 3	20 JEDEC TRAY (5+1)	No	Call TI	Call TI	-55 to 125	LM137H/883 Q ACO LM137H/883 Q >T
LM137H1PQMLV	Active	Production	TO (NDT) 3	20 JEDEC TRAY (5+1)	No	Call TI	Call TI	-55 to 125	LM137H1PQMLV 5962P9951708VXA Q ACO 5962P9951708VXA Q >T
LM137K/883	Active	Production	TO (K) 2	50 TRAY NON-STD	No	Call TI	Call TI	-55 to 125	(LM120H-15P+, LM13 7K) /883 Q ACO /883 Q >T
LM137KG MD8	Active	Production	DIESALE (Y) 0	120 JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM137KG-MW8	Active	Production	WAFERSALE (YS) 0	1 NOT REQUIRED	-	Call TI	Level-1-NA-UNLIM	-55 to 125	

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

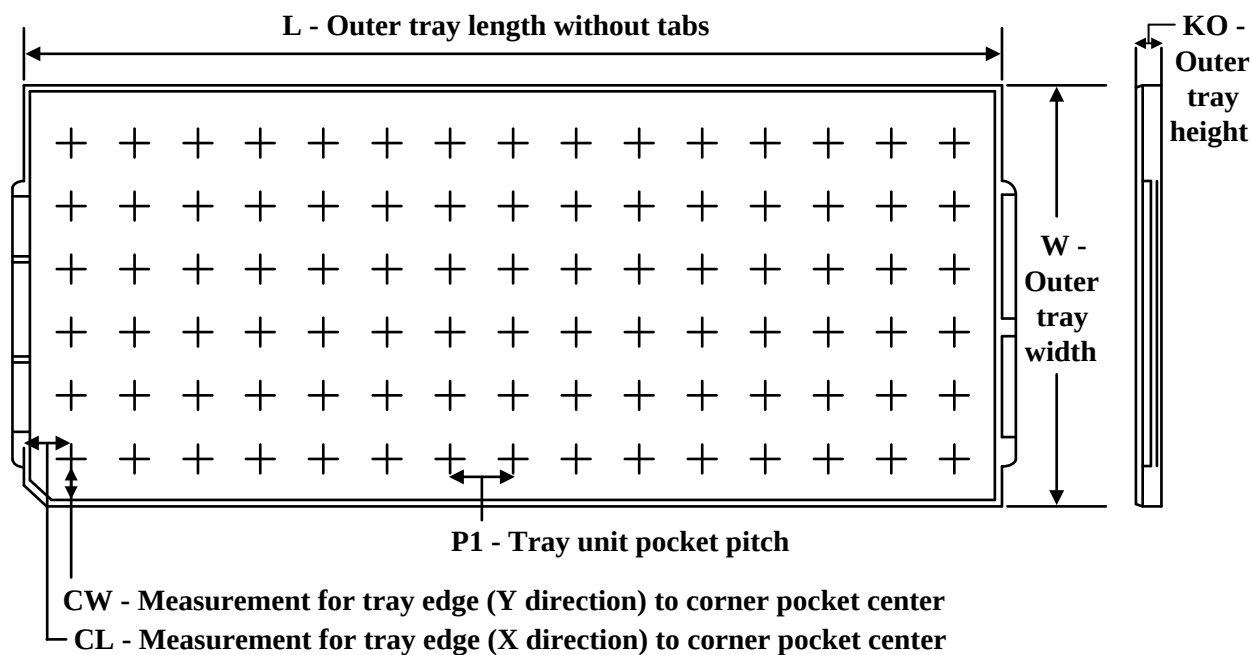
OTHER QUALIFIED VERSIONS OF LM137QML, LM137QML-SP :

- Military : [LM137QML](#)
- Space : [LM137QML-SP](#)

NOTE: Qualified Version Definitions:

- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (μm)	P1 (mm)	CL (mm)	CW (mm)
5962P9951708VXA	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM137H/883	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM137H1PQMLV	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM137K/883	K	TO-CAN	2	50	9 X 6	NA	292.1	215.9	25654	3.87	22.3	25.4

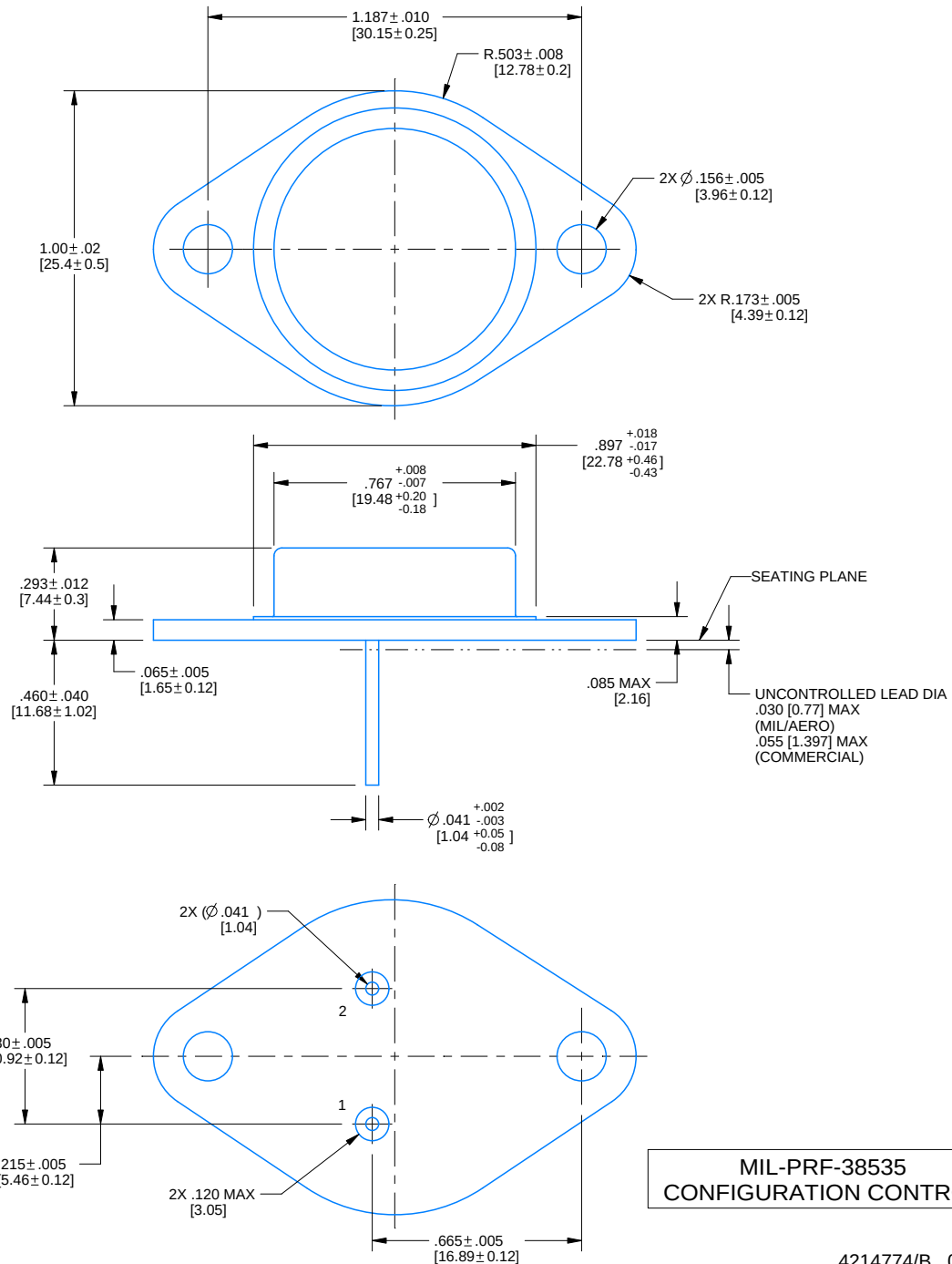
K0002A



PACKAGE OUTLINE

TO-CAN - 7.747 mm max height

TRANSISTOR OUTLINE



4214774/B 09/2024

NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Leads not to be bent greater than 15° .



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025